

## **DATASHEET**

# 0805 Package Infrared LED **EAIST2012A1**



#### **Features**

- High reliability
- Small double-end package
- Peak wavelength λp=850nm
- Package in 8mm tape on 7" diameter reel
- Low forward voltage
- Pb free
- The product itself will remain within RoHS compliant version.
- Compliance with EU REACH
- Compliance Halogen Free.(Br<900 ppm,Cl<900 ppm,Br+Cl<1500 ppm)

### **Descriptions**

- EAIST2012A1 is an infrared emitting diode in miniature SMD package which is molded in a water clear plastic with flat top view lens.
- The device is spectrally matched with silicon photodiode and phototransistor.

# **Applications**

- PCB mounted infrared sensor
- Infrared remote control units with high power requirement
- Smoke detector
- Infrared applied system

#### **Device Selection Guide**

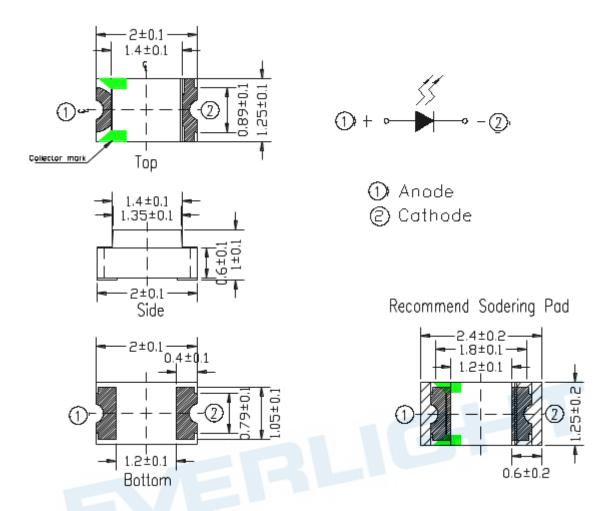
Part Category	Chip Material	Resin Color
EAIST2012A1	GaAlAs	Water Clear

Copyright © 2016, Everlight Americas Inc. All Rights Reserved. Release Date :2016/12/1.

www.everlightamericas.com



# **Package Dimensions**



Notes: 1.All dimensions are in millimeters

- 2.Tolerances unless dimensions ±0.1mm
- 3.Suggested pad dimension is just for reference only Please modify the pad dimension based on individual need



**Absolute Maximum Ratings (Ta=25°C)** 

Parameter	Symbol	Rating	Unit
Continuous Forward Current	I <sub>F</sub>	65	mA
Peak Forward Current *1	I <sub>FP</sub>	1.0	А
Reverse Voltage	$V_{R}$	5	V
Operating Temperature	$T_{opr}$	-40 ~ +85	$^{\circ}\!\mathbb{C}$
Storage Temperature	$T_{stg}$	-40 ~ +100	$^{\circ}\!\mathbb{C}$
Soldering Temperature *2	$T_{sol}$	260	$^{\circ}\!\mathbb{C}$
Power Dissipation at (or below)	C	400	mW
25° Free Air Temperature	$P_d$	130	11100

**Notes:** \*1: I<sub>FP</sub> Conditions--Pulse Width ≤ 100µs and Duty ≤ 1%.

Electro-Optical Characteristics (Ta=25°C)

Lieutio-Optical Offaracteristics (1a=25 C)						
Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Radiant Intensity	le	I <sub>F</sub> =20mA	1.60	2.10		mW /sr
Peak Wavelength	λр	I <sub>F</sub> =20mA 8		850		nm
Spectral Bandwidth	Δλ	I <sub>F</sub> =20mA	-	30		nm
		I <sub>F</sub> =20mA	1.20	1.40	1.70	
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> =100mA Pulse Width≦100μs, Duty≦1%	1.40	1.60	2.20	V
Reverse Current	I <sub>R</sub>	V <sub>R</sub> =5V			10	μA
View Angle	201/2	I <sub>F</sub> =20mA		120		deg

Reverse Light Current Specifications for Bin Grading

Rank	Condition	Min.	Max.	Unit	
Kalik	Condition	IVIIII.	IVIAA.	Offic	
А	I <sub>F</sub> =20mA	1.60	2.04		
В		1.96	2.45		
С		2.35	2.85	mW/sr	
D		2.74	3.20		

<sup>\*2:</sup> Soldering time ≤ 5 seconds.



## **Typical Electro-Optical Characteristics Curves**

Fig.1 Forward Current vs.

Ambient Temperature

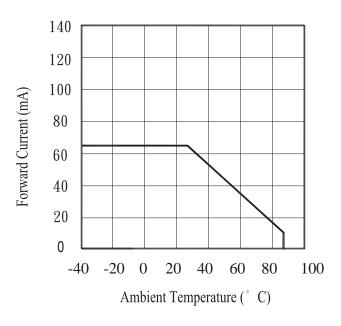


Fig.2 Spectral Distribution

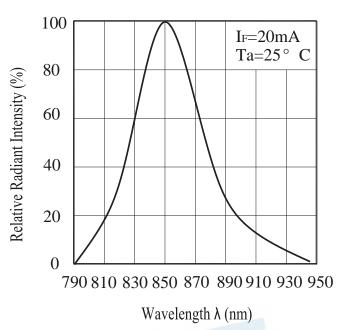


Fig.3 Forward Current vs. Forward Voltage

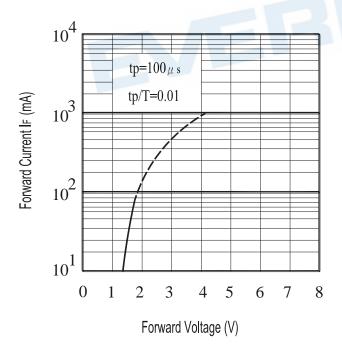
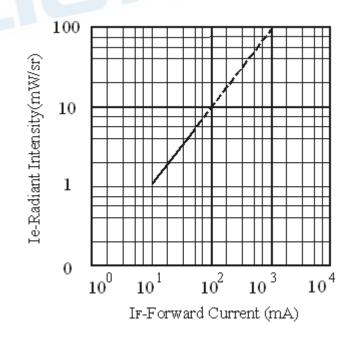


Fig.4 Relative Intensity vs.

Forward Current

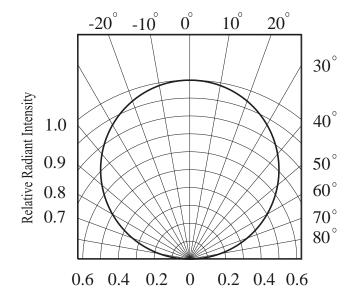




## **Typical Electro-Optical Characteristics Curves**

Fig.5 Relative Radiant Intensity vs.

**Angular Displacement** 





Ver.:2



#### **Precautions For Use**

#### 1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

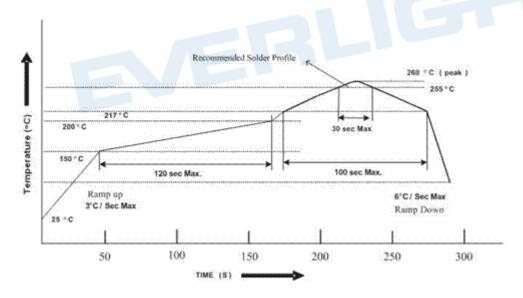
#### 2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30 ℃ or less and 90%RH or less.
- 2.3 The LEDs should be used within a year.
- 2.4 After opening the package, the LEDs should be kept at 30°C or less and 60%RH or less.
- 2.5 The LEDs should be used within 168 hours (7 days) after opening the package.
- 2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

  Baking treatment: 60±5°C for 48 hours.

#### 3. Soldering Condition

3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

Ver.:2

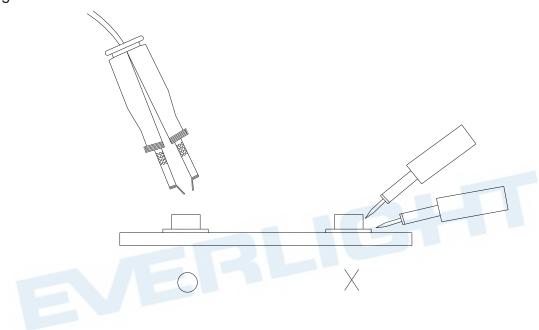


#### 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

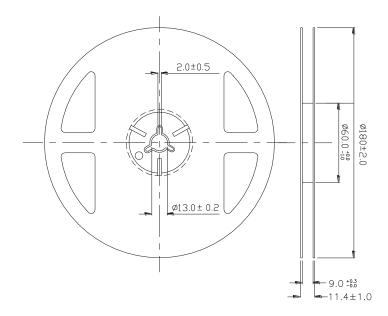
#### 5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



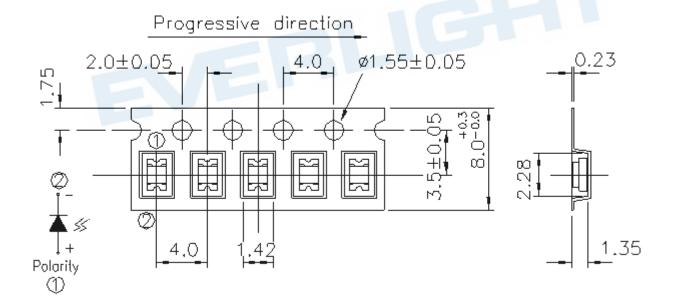


# **Package Dimensions**



**Note:** The tolerances unless mentioned are ±0.1 mm, unit: mm.

# **Carrier Taping Dimensions: (Quantity: 2000PCS/Reel)**

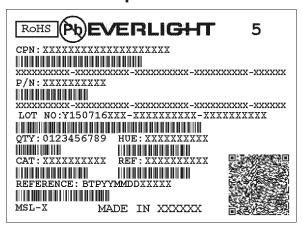


**Note:** The tolerances unless mentioned is ±0.1 mm, Unit: mm.

Ver.:2



### **Label Form Specification**



CPN: Customer's Production Number

P/N: Production Number LOT No: Lot Number QTY: Packing Quantity

HUE: Peak Wavelength

CAT: Ranks

REF: Reference MSL-X: MSL Level

Made In: Manufacture place

#### **DISCLAIMER**

- 1. EVERLIGHT reserves the right(s) on the adjustment of product material mix for the specification.
- 2. The product meets EVERLIGHT published specification for a period of twelve (12) months from date of shipment.
- 3. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
- 4. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from the use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
- 5. These specification sheets include materials protected under copyright of EVERLIGHT. Reproduction in any form is prohibited without obtaining EVERLIGHT's prior consent.
- 6. This product is not intended to be used for military, aircraft, automotive, medical, life sustaining or life saving applications or any other application which can result in human injury or death. Please contact authorized Everlight sales agent for special application request.

EVERLIGHT ELECTRONICS CO., LTD.

Office: No. 6-8, Zhonghua Rd., Shulin Dist.,

New Taipei City 23860, Taiwan

Tel: 886-2-2685-6688 Fax: 886-2685-2699, 6897

http://www.everlight.com

9

Copyright © 2016, Everlight Americas Inc. All Rights Reserved. Release Date :2016/12/1.

www.everlightamericas.com

Issue No: DIR-0001372 Rev:2